

Printing of organic light emitting diodes on textile

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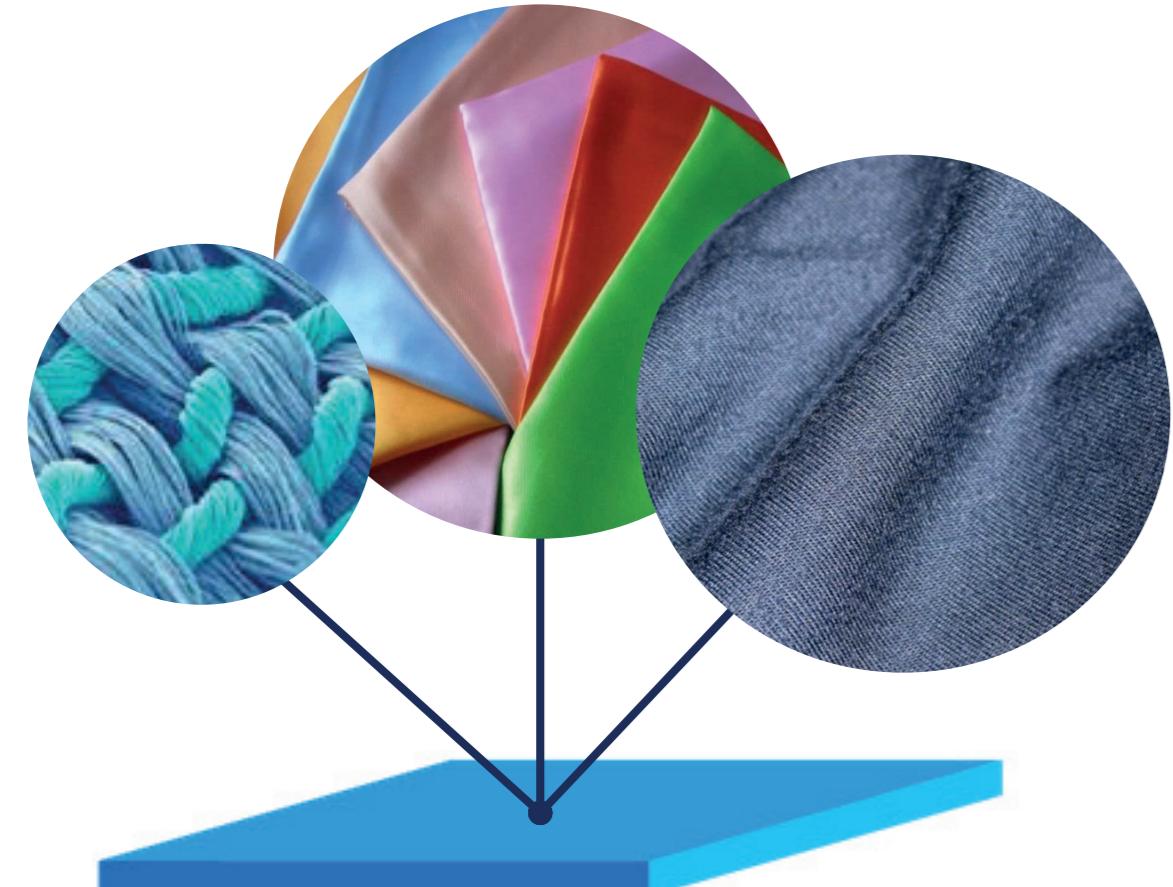
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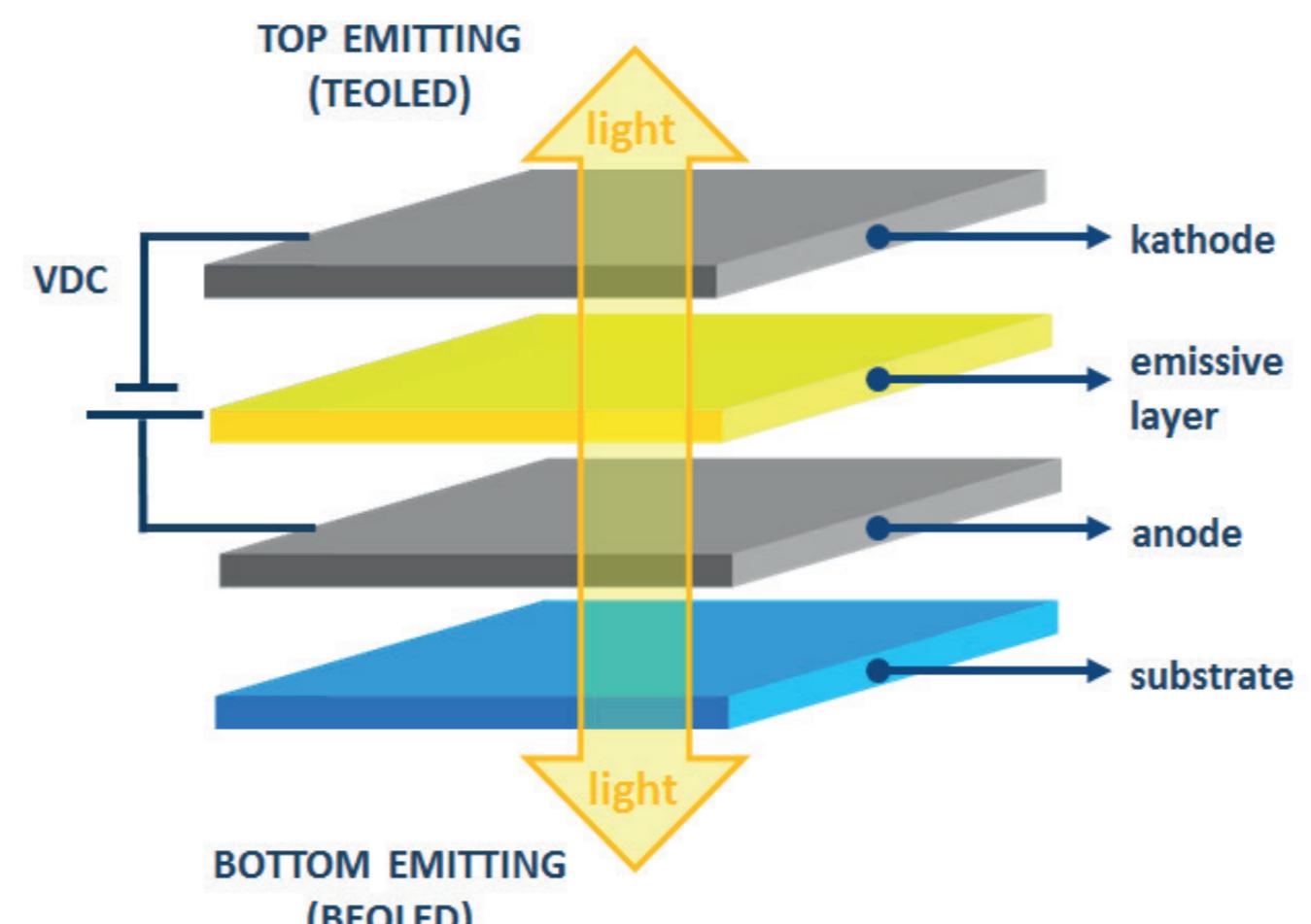
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Introduction

Textile substrate

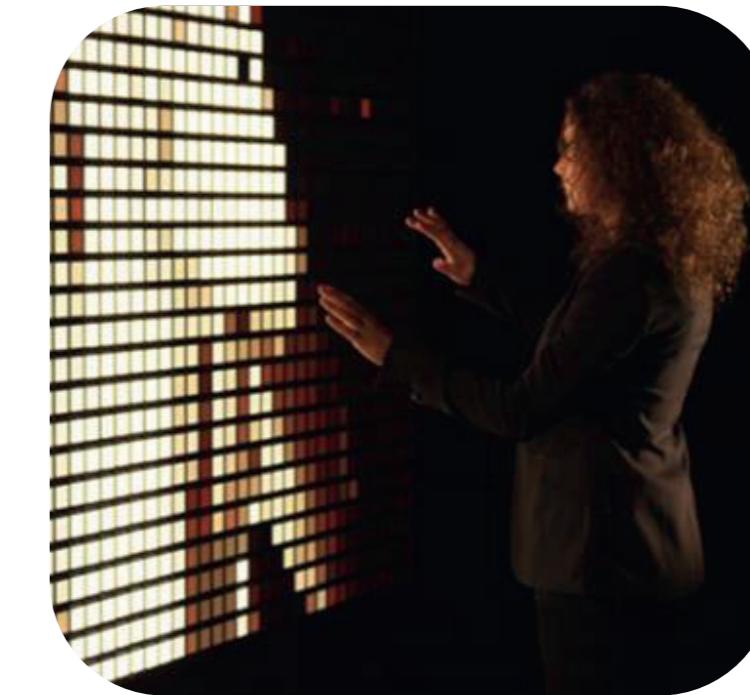


Top emitting organic light emitting diode[1] [2]



Applications

- ▶ Protective or safety clothing
- ▶ Indoor and outdoor design
- ▶ Advertisement
- ▶ Healthcare applications



Experimental

OLED stack



Material

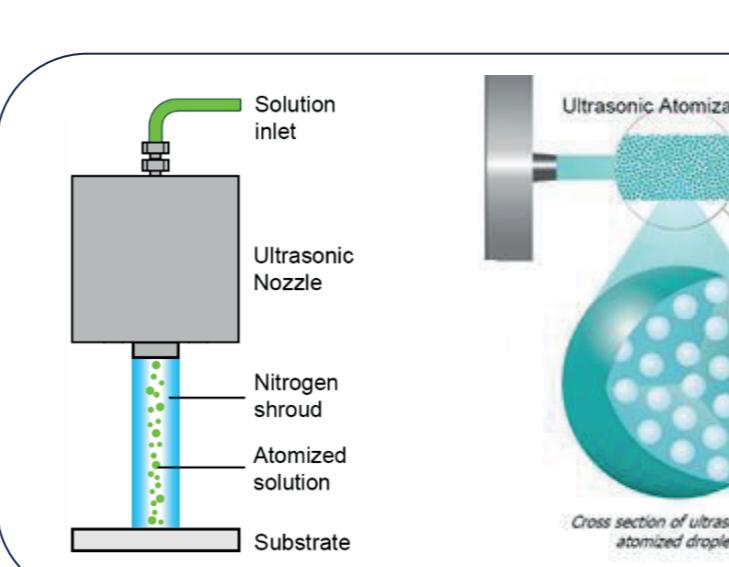
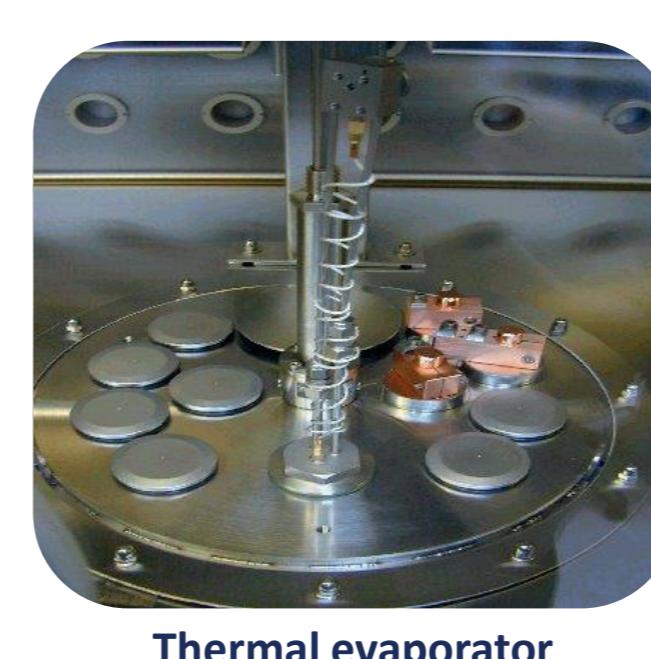
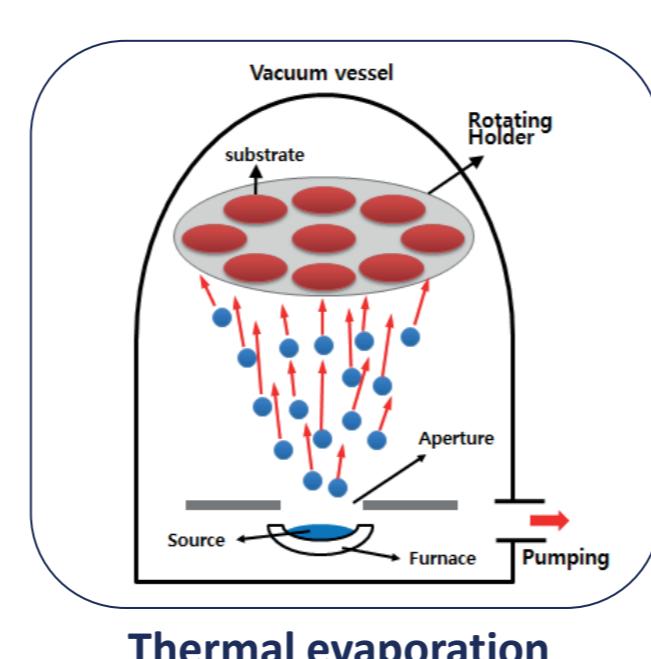
Encapsulation



Ca / Ag top contact

- ▶ 12 nm Ca / 17 nm Ag
- ▶ Transparent contact
- ▶ Thermal evaporation (vacuum deposition technique)

Techniques



Super Yellow

- ▶ 80 nm
- ▶ Organic emission layer
- ▶ Spin coating
- ▶ Ultrasonic spray coating



PEDOT PSS

- ▶ 35 nm
- ▶ Hole Injection Layer
- ▶ Spin coating



Ag bottom contact

- ▶ 200 nm
- ▶ Thermal evaporation
- ▶ Ink jet printing



Encapsulation

- ▶ To avoid contact with water vapor and oxygen
- ▶ Plasma techniques



Covering layer

- ▶ Roughness textile to high for nano-layers OLED
- ▶ PU, acrylic, PMMA, ...



References

- [1] D.-Y. Chung, J. Huang, D.D.C. Bradley, A.J. Campbell, *Organic Electronics* **11**(6), 1088–1095, (2010)
[2] J.-S Park, H. Chae, , H. K. Chung & S. I. Lee, *Semiconductor Science and Technology* **26**(3), (2011)

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